PICA: Parallel Image Compositing API Overview

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Scalable Visualization: Compositors

"Standard" commodity clusters

Nodes, GPU, Interconnect + PowerWalls + Remote displays

Multiple goals, but fundamentally aggregation

- Interaction/VR: High frame rates
- PowerWalls: Large pixel counts
- Data scaling: High polygon/fill rates
- Image Quality: Full scene anti-aliasing

Hardware for "compositing" focused on:

- Application transparency
- Parallel rendering models

Compositing solutions vary considerably:

- HP sv6/sv7, Lightning2, Sepia, SGE, Orad, SGI multi-pipe SDK
- Both transparent and opaque APIs





Inhibitors to Compositor Adoption

Small market, How many clusters out there?

- No such thing as a "standard" cluster
- Most clusters do not have physical compositor solutions

Few applications

- No common rendering infrastructure for parallel apps
- No common API for compositors
 - Application transparent modes are scalability limited
 - Invasive/custom interfaces to devices for "special features"
 - "Expensive" for ISVs to support
- Lack of 2D integration with 3D
 - Application interaction models change
- ASCI scalable rendering stack targets this

Hardware limitations exist

Capabilities of COTS graphics cards





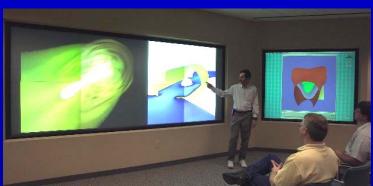
Parallel Image Compositing API (PICA)

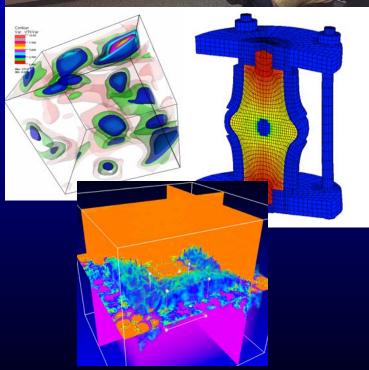
System developers and early adopting app developers

- Mostly HP, PNNL and LLNL employees
- Informal API discussions

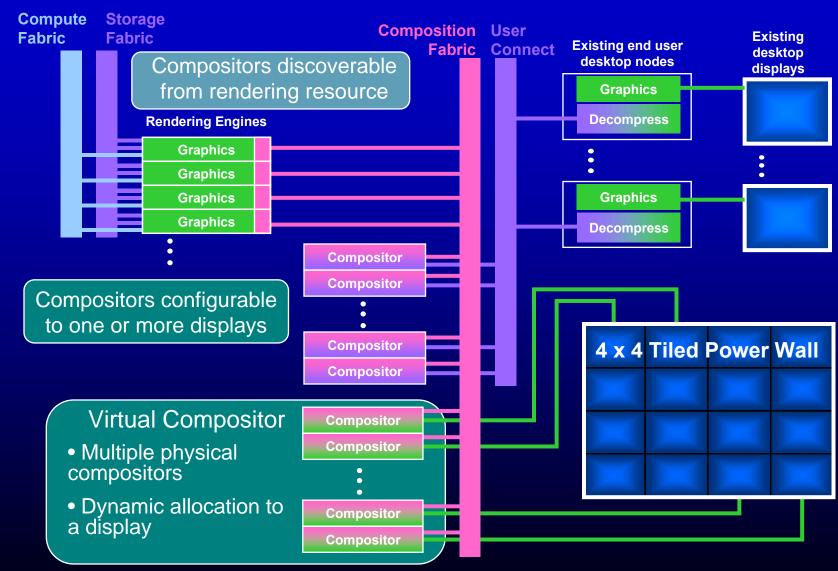
Goals

- Abstraction for distributed image composition, both 2D and 3D
- Provide an open source API adoptable by ISVs
- Provides a platform for SW implementations
- Support major hardware compositors
- Allow for optimal implementations
 - Maximize parallel opportunities
 - Avoid explicit collective operations





An Idealized Visualization Environment



Underling Assumptions

API targets parallel applications

- Simple parallel model assumptions
- Application can pass messages to itself

API must handle various input sources

- Region of graphics card memory
- Software rendering to main memory
- Must support "windowed" applications

API must provide a complete compositing abstraction

- Compositing function pipeline covering common usage
- Abstract the concept of composite "ordering"

Independent of graphics API

DirectX, OpenGL, Custom renderer

Must abstract all current compositor forms

- Multiple compositors available in the same cluster
- DVI based, network based, software, etc.



Basic PICA Abstractions

Application "Nodes"

- A source of image framelets, includes rendering resource
 - Not the same as a cluster node
- Supports a partition of the application execution

Application generates a sequence of "Frames"

- Frames are sequenced by IDs
- Limited queries Supported via frame IDs
- Multiple frame "channels" for stereo

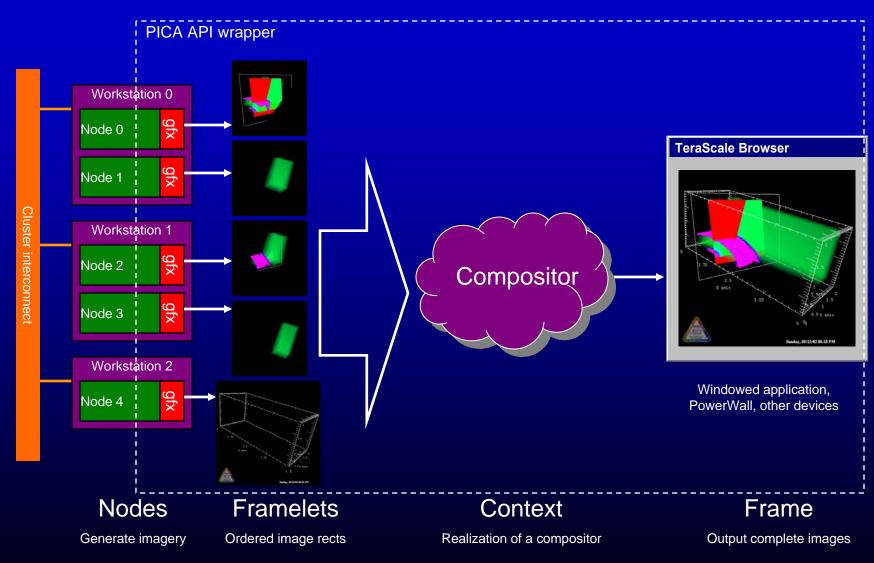
Frames are built from multiple "Framelets"

- An framelet is a (rendered) rectangle of augmented (e.g. α & depth) pixels
- Individual nodes can submit multiple framelets
- Framelets can be located anywhere in a frame
- Framelets are tagged with an "order" number within each frame

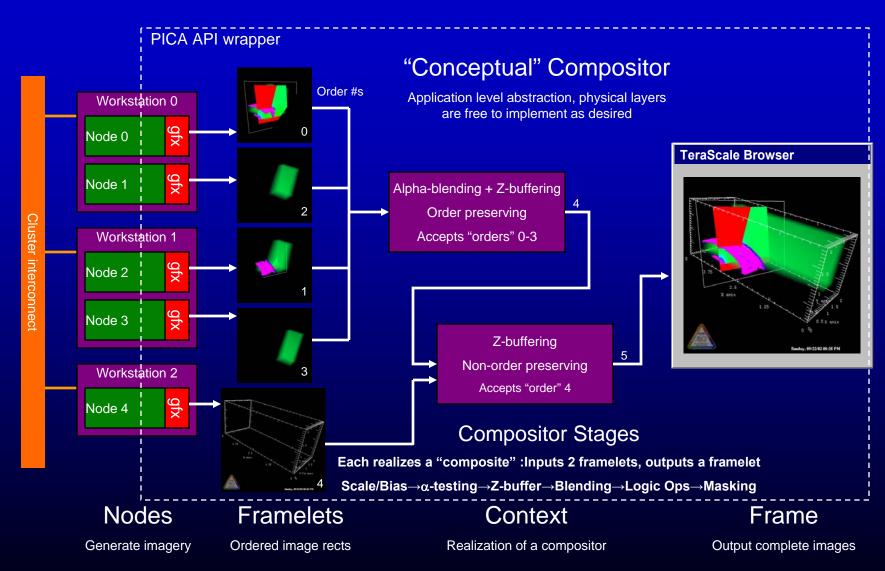
"OpenGL"-style compositing pipeline

- Multiple conceptual "stages" of OpenGL compositing supported
- Framelet "order" values specify the route through the stages

Compositing Operation in PICA



Compositing Operation in PICA:Details



Basic PICA Operation

Compositing "context" negotiated (one node)

- Includes compositing pipeline definition
- Hardware is allocated

Context ID is passed to nodes by application Context is "bound" locally (all nodes) to realize the system

Application starts a frame (all nodes)

- Application renders graphics (generates framelets)
- Framelets are passed to local context

Application ends the frame (all nodes)

Composite may occur asynchronously

Basic query functions allow for application feedback

Technical Details

Compositing at application rates, not display rates

Designed to support 99% of applications

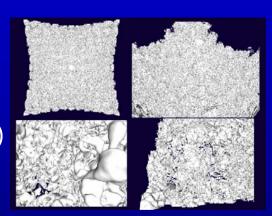
- Sorted, alpha blending (e.g. volume rendering)
- Tiling
- "Overlays" (e.g. annotations, heads-up-displays)

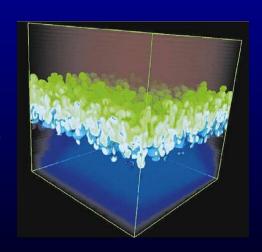
Advanced composites supported as well

- Full-screen anti-aliasing
- HW assisted "transparency"

Mechanisms for application "hinting"

- Performance optimizations (e.g. composite trees)
- Information regarding the degree of HW assist
- Negotiation of "special features"





Additional Supported API Features

"Negotiated" compositor features

- Incomplete compositor crossbar
 - Local order constraints
- Non-volatile frame buffers
 - Incremental/frameless rendering w/copyswap devices
- Window system "aware", buffer & "wall" mode rendering
- Dynamic composite functions, framelet scaling

Integration with Chromium

- Cr lacks sufficient information to exploit HW
 - Need standard way of exposing this to applications
- Portions of PICA being adopted as the Cr interface
- Cr as optimization layer, PICA as realization for unaware apps

PICA Overview

Current Status

Second revision of the specification is complete

- In conjunction with Brian Paul, Tungsten Graphics
- "Human readable" specification next
- Basic startup on both SMP and distributed systems done

Development efforts

- "C" Stubs written for the API
- Compiles both apps and compositor
- Tiered shared library dispatch done
- Simple software compositor under development
- Test application under development

Future Steps: Making it Real...

USDC proposal by Tungsten Graphics

- Provide "RedBook" level documentation
 - Get API feedback from a wider audience
 - Researchers
 - Application writers
 - HW providers
 - Document expected usage models
- Create 1.0 sample implementation
 - Develop complete, reusable, SW version
 - Write drivers to support a HW compositor

Consider collected issues for version 2.0

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